

# Global SiC Wafer Thermal Laser Separation Cutting Equipment Market Growth 2026-2032

<https://marketpublishers.com/r/GD07B226180DEN.html>

Date: March 2026

Pages: 81

Price: US\$ 3,660.00 (Single User License)

ID: GD07B226180DEN

## Abstracts

The global SiC Wafer Thermal Laser Separation Cutting Equipment market size is predicted to grow from US\$ 15.74 million in 2025 to US\$ 27.22 million in 2032; it is expected to grow at a CAGR of 8.3% from 2026 to 2032.

According to our Semiconductor Research Center, in 2022, the global SiC wafer was valued at US\$ 750 million, will grow rapidly in next six years, driven by the strong demand from electric vehicle (EV). Currently the 6 inch SiC substrates are dominating this market, and in next six years, more players will put into production the 8 inch SiC wafers. Currently the key players of SiC are mainly located headquartered United States, Europe, Japan and China, especially in China, more companies are entering the SiC market. It is predicted that, Chinese companies will play key roles in the SiC market in next ten years.

LP Information, Inc. (LPI) ' newest research report, the "SiC Wafer Thermal Laser Separation Cutting Equipment Industry Forecast" looks at past sales and reviews total world SiC Wafer Thermal Laser Separation Cutting Equipment sales in 2025, providing a comprehensive analysis by region and market sector of projected SiC Wafer Thermal Laser Separation Cutting Equipment sales for 2026 through 2032. With SiC Wafer Thermal Laser Separation Cutting Equipment sales broken down by region, market sector and sub-sector, this report provides a detailed analysis in US\$ millions of the world SiC Wafer Thermal Laser Separation Cutting Equipment industry.

This Insight Report provides a comprehensive analysis of the global SiC Wafer Thermal Laser Separation Cutting Equipment landscape and highlights key trends related to product segmentation, company formation, revenue, and market share, latest development, and M&A activity. This report also analyzes the strategies of leading

global companies with a focus on SiC Wafer Thermal Laser Separation Cutting Equipment portfolios and capabilities, market entry strategies, market positions, and geographic footprints, to better understand these firms' unique position in an accelerating global SiC Wafer Thermal Laser Separation Cutting Equipment market.

This Insight Report evaluates the key market trends, drivers, and affecting factors shaping the global outlook for SiC Wafer Thermal Laser Separation Cutting Equipment and breaks down the forecast by Type, by Application, geography, and market size to highlight emerging pockets of opportunity. With a transparent methodology based on hundreds of bottom-up qualitative and quantitative market inputs, this study forecast offers a highly nuanced view of the current state and future trajectory in the global SiC Wafer Thermal Laser Separation Cutting Equipment.

This report presents a comprehensive overview, market shares, and growth opportunities of SiC Wafer Thermal Laser Separation Cutting Equipment market by product type, application, key manufacturers and key regions and countries.

**Segmentation by Type:**

for 6 inches wafer

for 8 inches wafer

**Segmentation by Application:**

Foundry

IDM

**This report also splits the market by region:**

Americas

United States

Canada

Mexico

Brazil

## APAC

China

Japan

Korea

Southeast Asia

India

Australia

## Europe

Germany

France

UK

Italy

Russia

## Middle East & Africa

Egypt

South Africa

Israel

Turkey

## GCC Countries

The below companies that are profiled have been selected based on inputs gathered from primary experts and analysing the company's coverage, product portfolio, its market penetration.

3D-Micromac AG

### **Key Questions Addressed in this Report**

What is the 10-year outlook for the global SiC Wafer Thermal Laser Separation Cutting Equipment market?

What factors are driving SiC Wafer Thermal Laser Separation Cutting Equipment market growth, globally and by region?

Which technologies are poised for the fastest growth by market and region?

How do SiC Wafer Thermal Laser Separation Cutting Equipment market opportunities vary by end market size?

How does SiC Wafer Thermal Laser Separation Cutting Equipment break out by Type, by Application?

**The report requires updating with new data and is sent in 48 hours after order is placed.**

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